

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

<u>Texas Instruments</u> <u>SN74ALVCH162830GR</u>

For any questions, you can email us directly: sales@integrated-circuit.com



Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74ALVCH162830 1-BIT TO 2-BIT ADDRESS DRIVER WITH 3-STATE OUTPUTS

SCES082I-AUGUST 1996-REVISED JULY 2004

www.ti.com

Texas

NSTRUMENTS

FEATURES

- Member of the Texas Instruments Widebus™
 Family
- Output Ports Have Equivalent 26- Ω Series Resistors, So No External Resistors Are Required
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

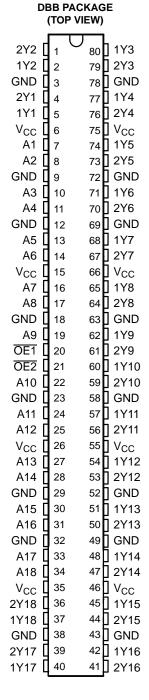
DESCRIPTION/ORDERING INFORMATION

This 1-bit to 2-bit address driver is designed for 1.65-V to 3.6-V V_{CC} operation.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

The outputs, which are designed to sink up to 12 mA, include equivalent 26- Ω resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments.



Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74ALVCH162830 1-BIT TO 2-BIT ADDRESS DRIVER

WITH 3-STATE OUTPUTS
SCES082I-AUGUST 1996-REVISED JULY 2004



ORDERING INFORMATION

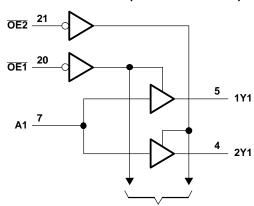
T _A	PACI	(AGE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	TVSOP - DBB	Tape and reel	SN74ALVCH162830GR	ALVCH162830

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

	INPUTS		OUTPUTS			
OE1	OE2	Α	1Yn	2Yn		
L	Н	Н	Н	Z		
L	Н	L	L	Z		
Н	L	Н	Z	Н		
Н	L	L	Z	L		
L	L	Н	Н	н		
L	L	L	L	L		
Н	Н	Χ	Z	z		

LOGIC DIAGRAM (POSITIVE LOGIC)



To 17 Other Channels



Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN74ALVCH162830 1-BIT TO 2-BIT ADDRESS DRIVER WITH 3-STATE OUTPUTS

SCES082I-AUGUST 1996-REVISED JULY 2004

ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

				MIN	MAX	UNIT
V _{CC}	Supply voltage range			-0.5	4.6	V
VI	Input voltage range (2)			-0.5	4.6	V
Vo	Output voltage range (2)(3)					V
I _{IK}	Input clamp current	V _I < 0			-50	mA
I _{OK}	Output clamp current			-50	mA	
Io	Continuous output current				±50	mA
	Continuous current through each V _{CC} or	GND			±100	mA
θ_{JA}	Package thermal impedance ⁽⁴⁾				64	°C/W
T _{stg}	Storage temperature range			-65	150	°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings (1) only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability

RECOMMENDED OPERATING CONDITIONS⁽¹⁾

			MIN	MAX	UNIT
V _{CC}	Supply voltage		1.65	3.6	V
		V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$		
V_{IH}	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		
		V _{CC} = 1.65 V to 1.95 V		$0.35 \times V_{CC}$	
V_{IL}	Low-level input voltage	V _{CC} = 2.3 V to 2.7 V		0.7	V
		V _{CC} = 2.7 V to 3.6 V		0.8	
VI	Input voltage	·	0	V _{CC}	V
Vo	Output voltage		0	V _{CC}	V
		V _{CC} = 1.65 V		-2	
	High lavel autout avenue	V _{CC} = 2.3 V		-6	mA
I _{OH}	High-level output current	V _{CC} = 2.7 V		-8	
		V _{CC} = 3 V		-12	
		V _{CC} = 1.65 V		2	
	Laur laurel austront austrant	V _{CC} = 2.3 V		6	mA
I _{OL}	Low-level output current	V _{CC} = 2.7 V		8	
		V _{CC} = 3 V		12	
Δt/Δν	Input transition rise or fall rate	·		10	ns/V
T _A	Operating free-air temperature		-40	85	°C

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

This value is limited to 4.6 V, maximum.

The package thermal impedance is calculated in accordance with JESD 51-7.



Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74ALVCH162830 1-BIT TO 2-BIT ADDRESS DRIVER WITH 3-STATE OUTPUTS



SCES082I-AUGUST 1996-REVISED JULY 2004

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

PA	ARAMETER	TEST CONDITIONS	v _{cc}	MIN	TYP ⁽¹⁾	MAX	UNIT			
		I _{OH} = -100 μA	1.65 V to 3.6 V	V _{CC} - 0.2						
		I _{OH} = -2 mA	1.65 V	1.2						
		I _{OH} = -4 mA	2.3 V	1.9						
V _{OH}		L 6 m A	2.3 V	1.7			V			
		I _{OH} = -6 mA	3 V	2.4						
		$I_{OH} = -8 \text{ mA}$	2.7 V	2			1			
		I _{OH} = -12 mA	3 V	2						
		I _{OL} = 100 μA	1.65 V to 3.6 V	•		0.2				
		I _{OL} = 2 mA	1.65 V			0.45				
		I _{OL} = 4 mA	2.3 V			0.4				
V _{OL}		L C 77.A	2.3 V	,		0.55	V			
		I _{OL} = 6 mA	3 V			0.55				
		I _{OL} = 8 mA	2.7 V			0.6				
		I _{OL} = 12 mA	3 V	3 V						
I _I		$V_1 = V_{CC}$ or GND 3.6 V		,		±5	μΑ			
		V _I = 0.58 V	1.65 V	25						
		V _I = 1.07 V	1.65 V	-25						
		V _I = 0.7 V	2.3 V	45						
I _{I(hold)}		V _I = 1.7 V	2.3 V	-45	,		μΑ			
` `		V _I = 0.8 V	3 V	75						
		V _I = 2 V	3 V	-75						
		V _I = 0 to 3.6 V ⁽²⁾	3.6 V			±500				
I _{OZ}		$V_O = V_{CC}$ or GND	3.6 V	,		±10	μΑ			
I _{CC}		$V_I = V_{CC}$ or GND, $I_O = 0$	3.6 V		,	40	μΑ			
ΔI_{CC}		One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND	3 V to 3.6 V			750	μΑ			
	Control inputs	V V or CND	227	4.5			pF			
C _i	Data Inputs	$V_I = V_{CC}$ or GND	3.3 V		5					
C _o	Outputs	$V_O = V_{CC}$ or GND	3.3 V		7.5		pF			

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 1.8 V	V _{CC} = 2 ± 0.2	2.5 V : V	V _{CC} = 2.7 V	V	cc = 3 ± 0.3	3.3 V V	UNIT
	(INPUT)	(001701)	TYP	MIN	MAX	MIN MA	X I	MIN MAX		
t _{pd}	А	Y	(1)	1.2	3.8		4	1.7	3.5	ns
t _{en}	ŌĒ	Y	(1)	1	5.7	5	.7	1	4.8	ns
t _{dis}	ŌĒ	Y	(1)	1.5	6.2	5	.4	1.7	5.2	ns

⁽¹⁾ This information was not available at the time of publication.

All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$. This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.



Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN74ALVCH162830 1-BIT TO 2-BIT ADDRESS DRIVER WITH 3-STATE OUTPUTS

SCES082I-AUGUST 1996-REVISED JULY 2004

OPERATING CHARACTERISTICS

 $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	V _{CC} = 1.8 V TYP	V _{CC} = 2.5 V TYP	V _{CC} = 3.3 V TYP	UNIT	
	Power dissipation capacitance	All outputs enabled	C 0 = E 1 10 MH=	(1)	50	54	pF
10	d per bit (two outputs switching)	All outputs disabled	$C_L = 0 \text{ pF, f} = 10 \text{ MHz}$	(1)	8	8	pr

⁽¹⁾ This information was not available at the time of publication.



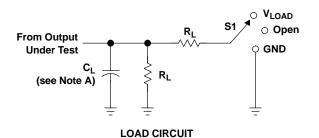
Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74ALVCH162830 1-BIT TO 2-BIT ADDRESS DRIVER WITH 3-STATE OUTPUTS

TEXAS INSTRUMENTS www.ti.com

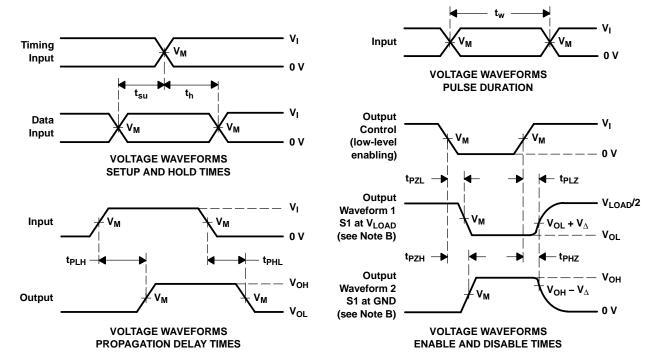
SCES082I-AUGUST 1996-REVISED JULY 2004

PARAMETER MEASUREMENT INFORMATION



TEST	S 1
t _{pd}	Open
t _{PLZ} /t _{PZL}	V _{LOAD}
t _{PHZ} /t _{PZH}	GND

	INPUT		.,			Б	.,
V _{CC}	VI	t _r /t _f	V _M	V _{LOAD}	CL	R_L	V_Δ
1.8 V	v _{cc}	≤2 ns	V _{CC} /2	2×V _{CC}	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	Vcc	≤2 ns	V _{CC} /2	2×V _{CC}	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C₁ includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω .
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



PACKAGE OPTION ADDENDUM

3-Apr-2006

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74ALVCH162830GRE4	ACTIVE	TSSOP	DBB	80	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ALVCH162830GRG4	ACTIVE	TSSOP	DBB	80	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALVCH162830DBBR	OBSOLETE	TSSOP	DBB	80		TBD	Call TI	Call TI
SN74ALVCH162830GR	ACTIVE	TSSOP	DBB	80	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

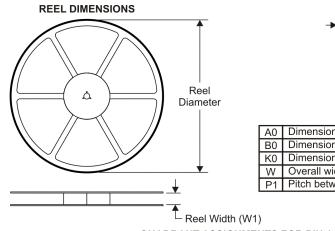
Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

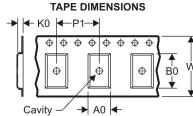


PACKAGE MATERIALS INFORMATION

11-Mar-2008

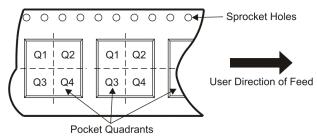
TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

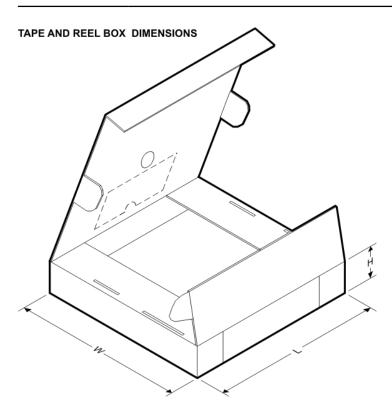
Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALVCH162830GR	TSSOP	DBB	80	2000	330.0	24.4	8.4	17.3	1.7	12.0	24.0	Q1

Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALVCH162830GR	TSSOP	DBB	80	2000	346.0	346.0	41.0

Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

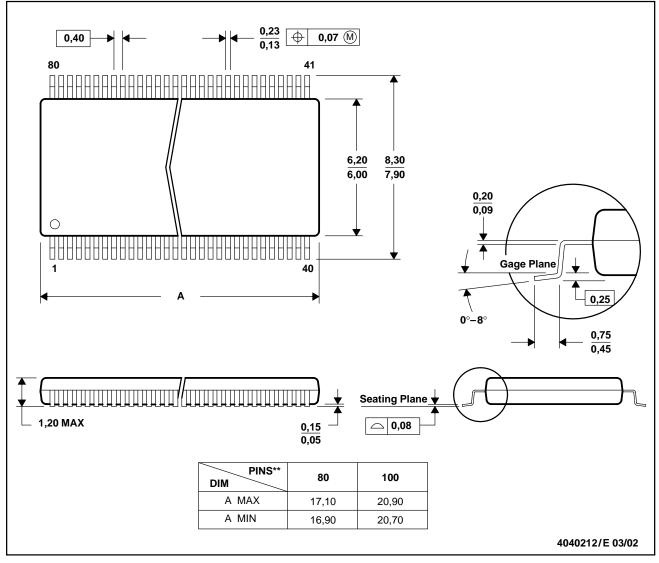
MECHANICAL DATA

MTSS005D - JANUARY 1995 - REVISED MARCH 2002

DBB (R-PDSO-G**)

80 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Falls within JEDEC: 80 Pin - MO-153 Variation FF

100 Pin - MO-194 Variation BB





Distributor of Texas Instruments: Excellent Integrated System Limited Datasheet of SN74ALVCH162830GR - IC ADDRESS DVR 1-2BIT 80TSSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products Applications Amplifiers Audio amplifier.ti.com Automotive Data Converters dataconverter.ti.com DSP dsp.ti.com Broadband Clocks and Timers www.ti.com/clocks **Digital Control** Interface Medical interface.ti.com Military Logic logic.ti.com Optical Networking Power Mgmt power.ti.com Microcontrollers Security microcontroller.ti.com Telephony www.ti-rfid.com RF/IF and ZigBee® Solutions Video & Imaging www.ti.com/lprf

Applications
Audio www.ti.com/audio
Automotive www.ti.com/automotive
Broadband www.ti.com/broadband
Digital Control www.ti.com/digitalcontrol
Medical www.ti.com/medical
Military www.ti.com/military
Optical Networking www.ti.com/opticalnetwork
Security www.ti.com/security
Felephony www.ti.com/telephony
Video & Imaging www.ti.com/video
Wireless www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2008, Texas Instruments Incorporated